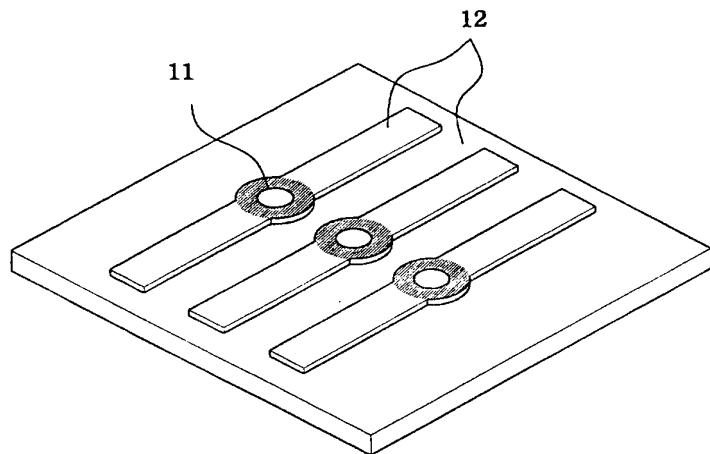


Title: METHOD OF FORMING SOLDER RESIST PATTERN
Inventors: Jee-Soo Mok, Jang-Kyu Kang, and Chang-Hyun Nam
Docket No.: LEPA121687

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Fig. 1

PRIOR ART



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Fig. 2

PRIOR ART

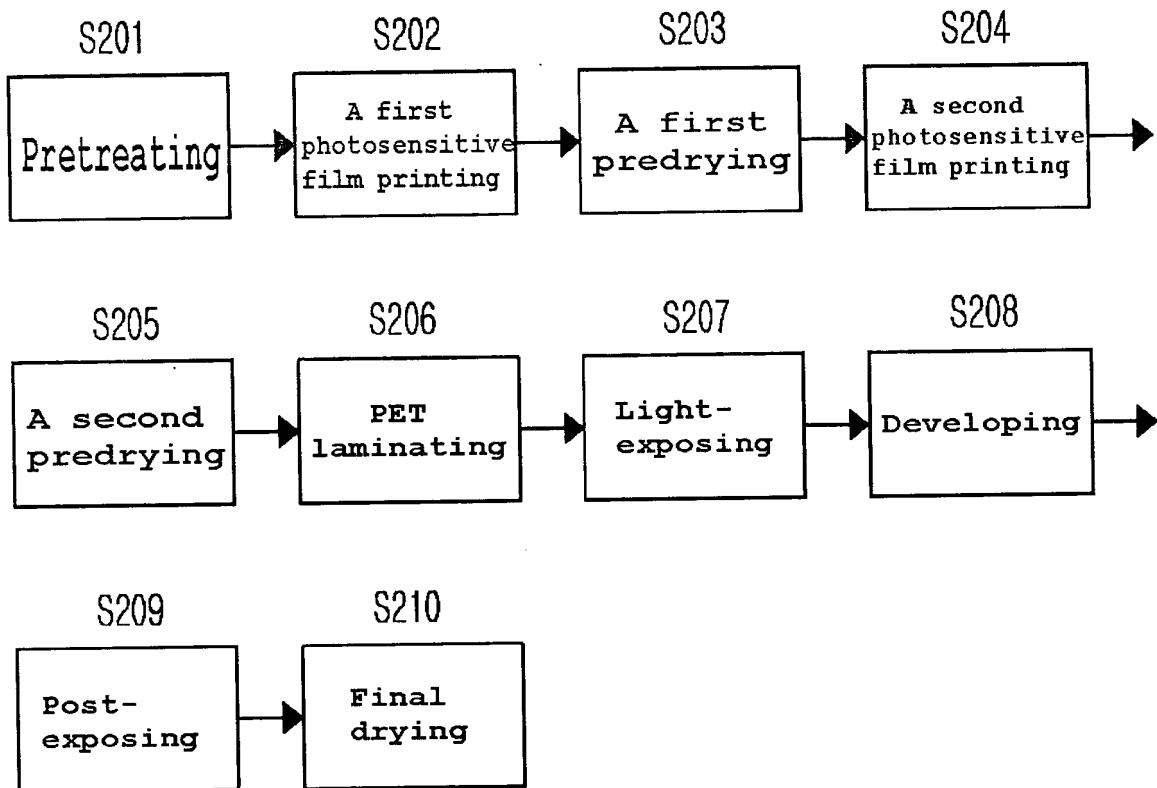
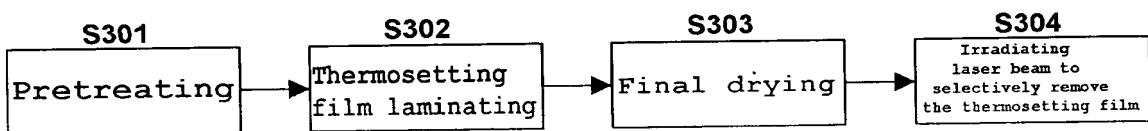


Fig. 3



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Fig. 4a

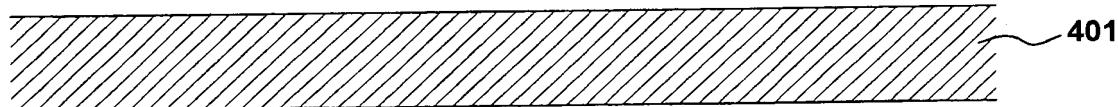


Fig. 4b

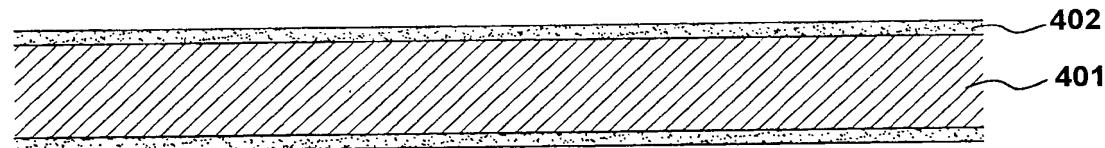
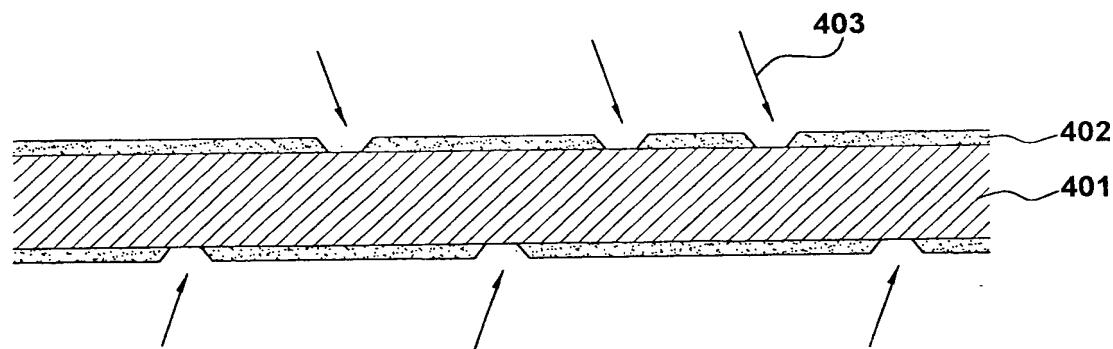


Fig. 4c



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Fig. 5a

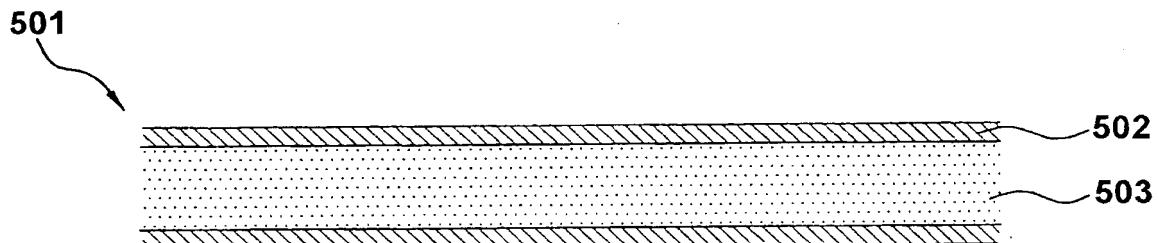


Fig. 5b

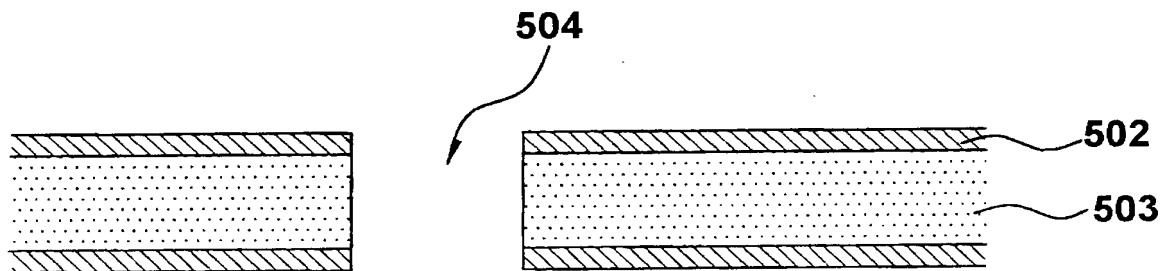
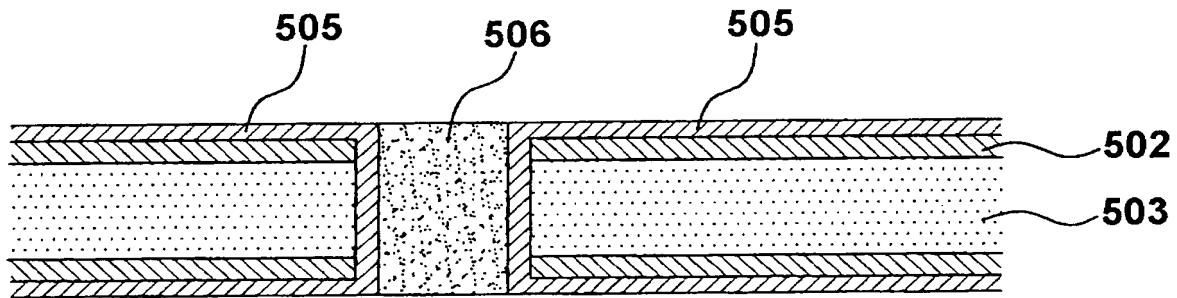


Fig. 5c



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Fig. 5d

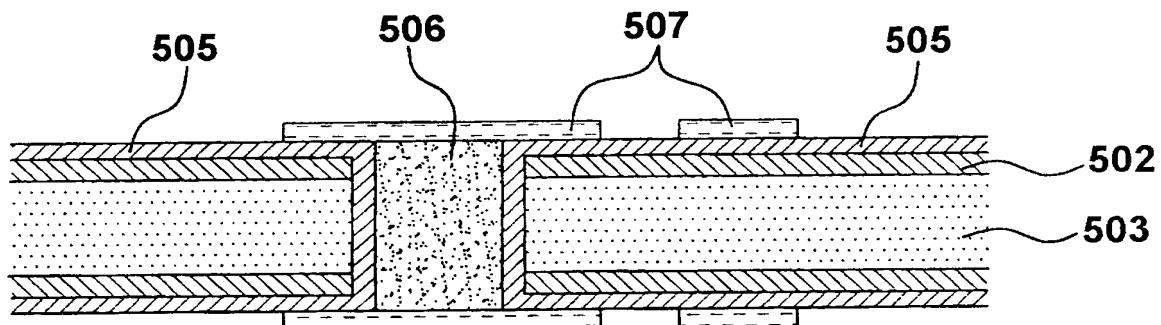


Fig. 5e

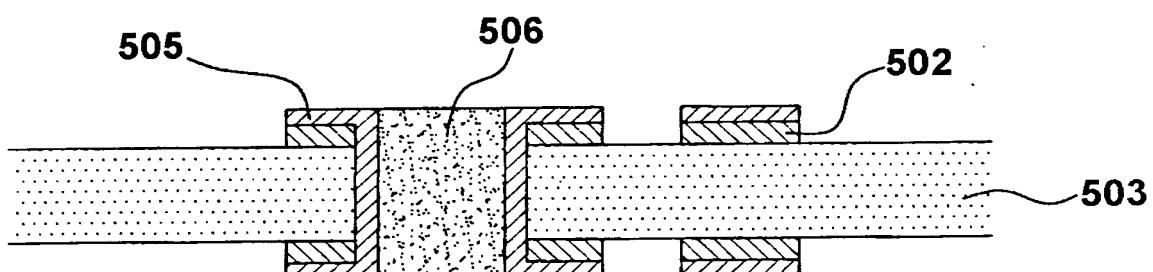
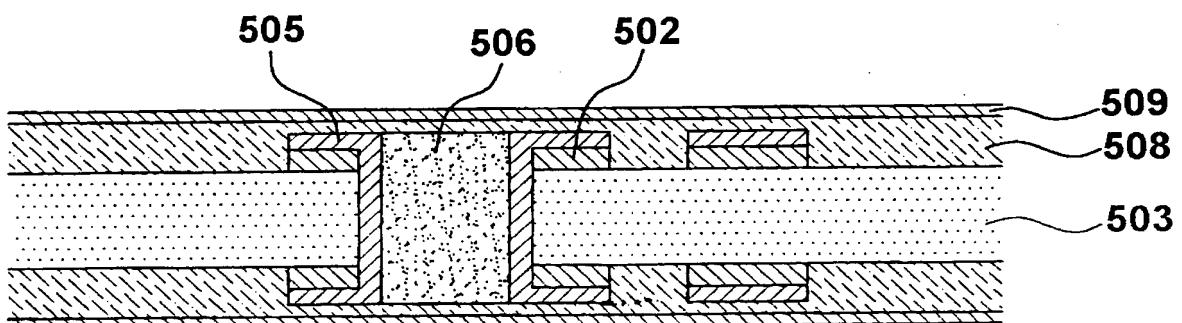


Fig. 5f



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Fig. 5g

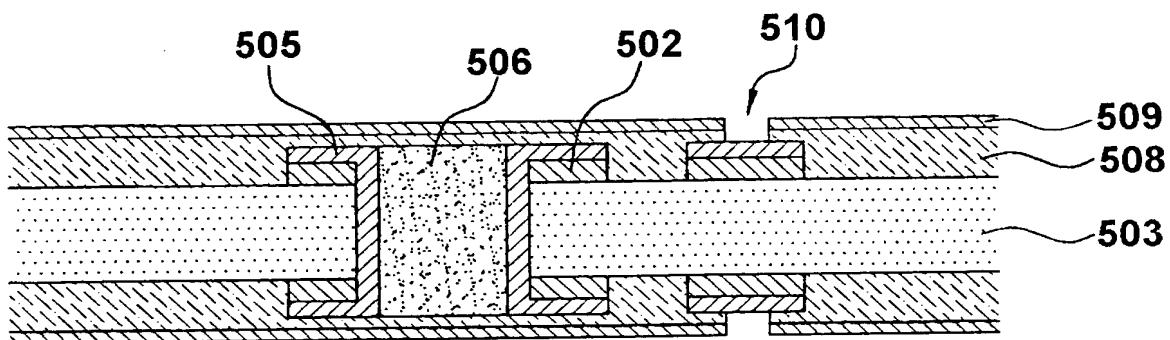


Fig. 5h

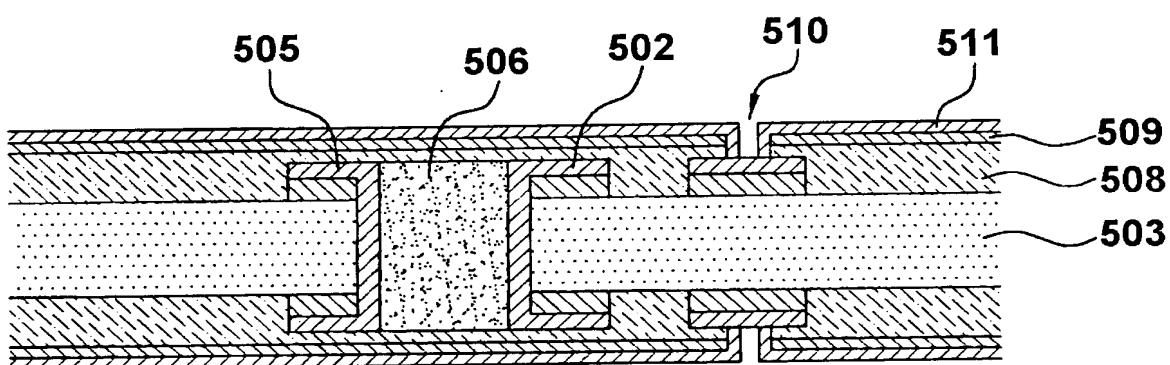
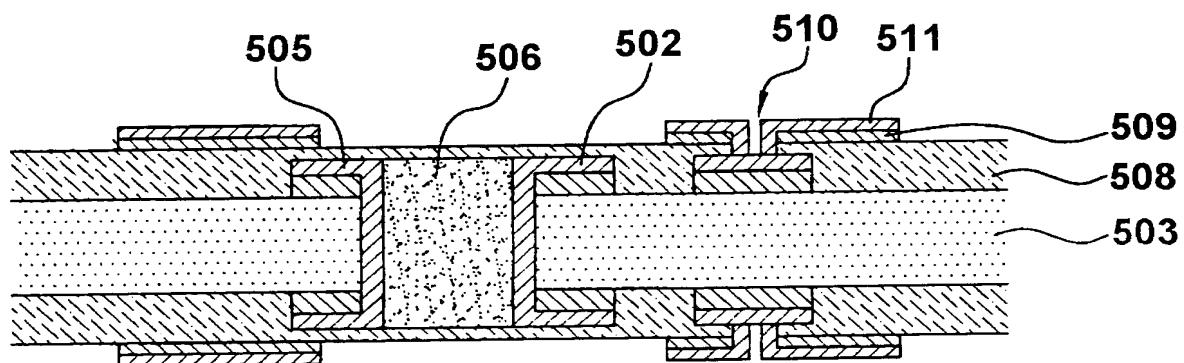


Fig. 5i



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Fig. 5j

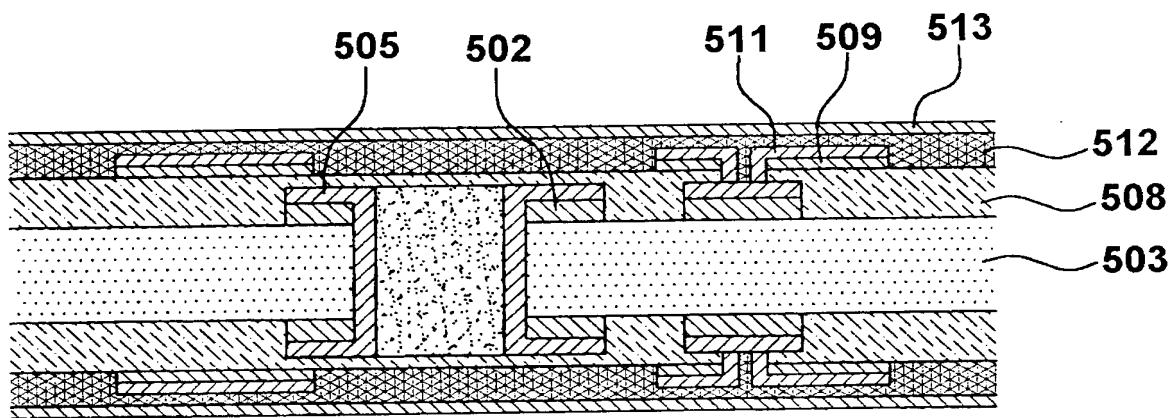
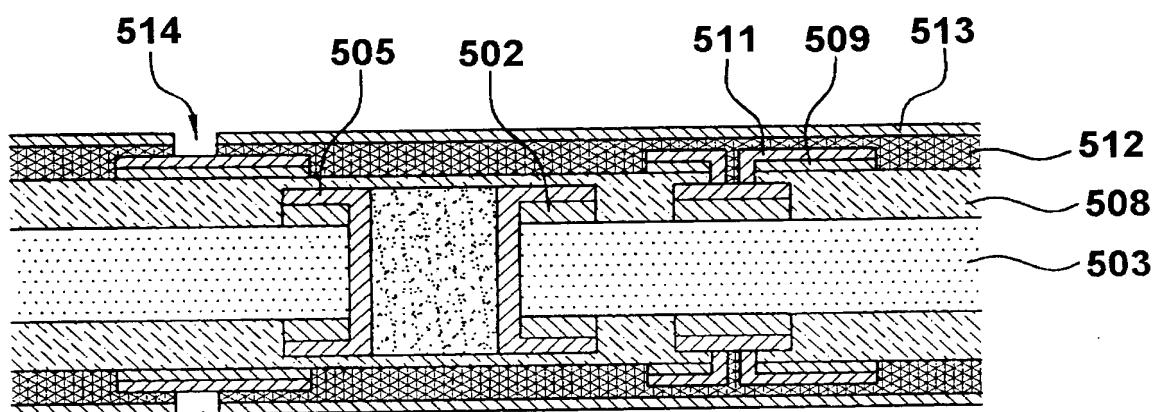


Fig. 5k



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Fig. 5l

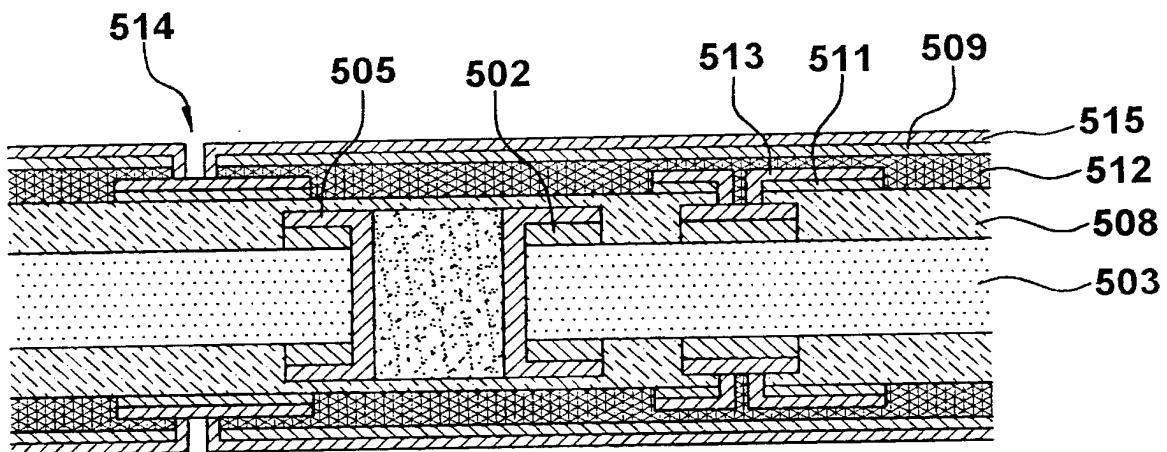
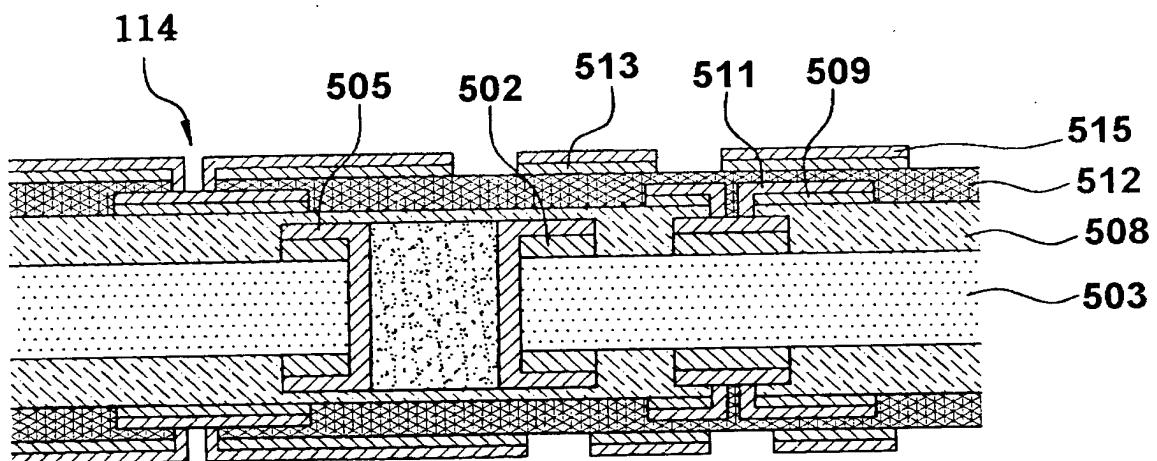


Fig. 5m



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Fig. 5n

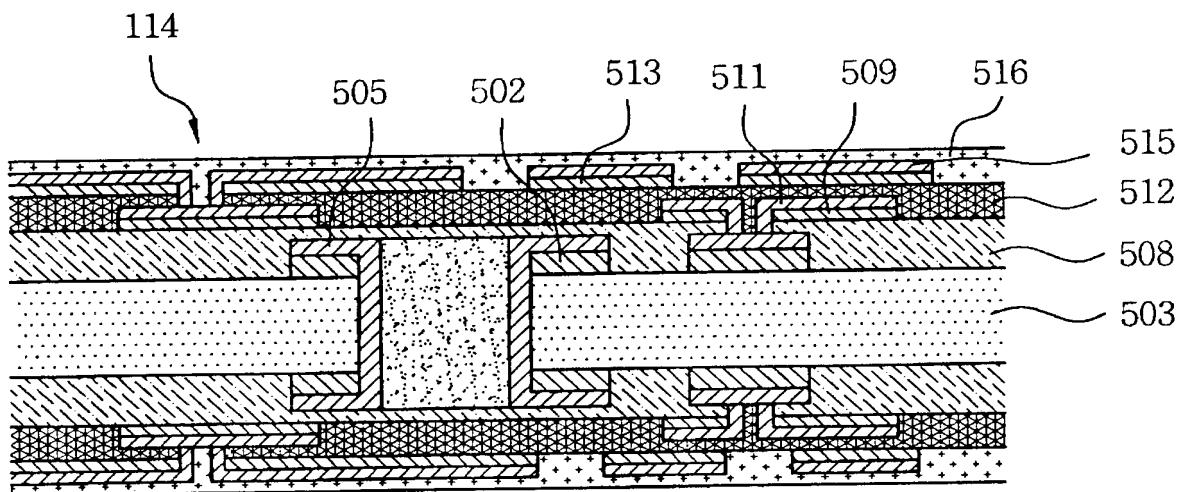
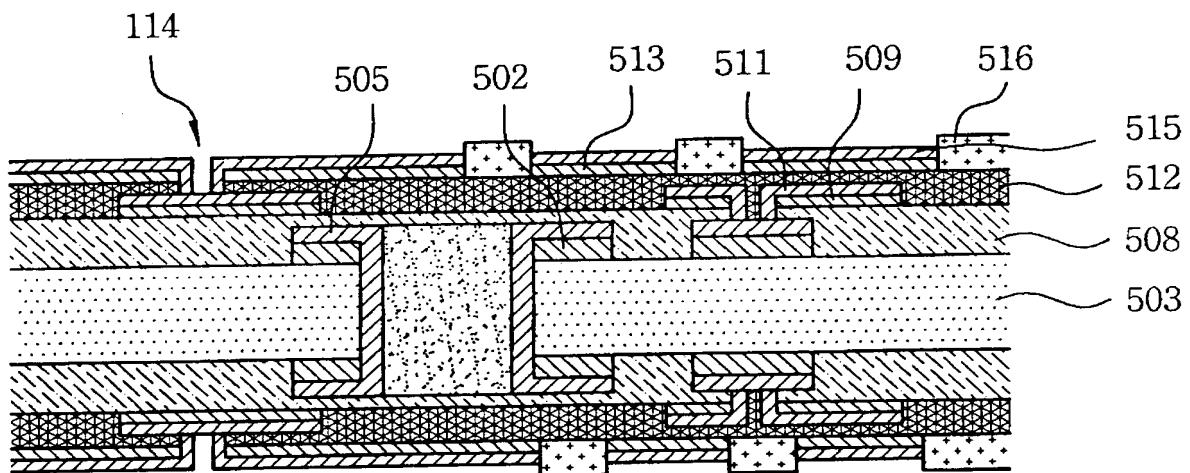


Fig. 5o



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Fig. 6a

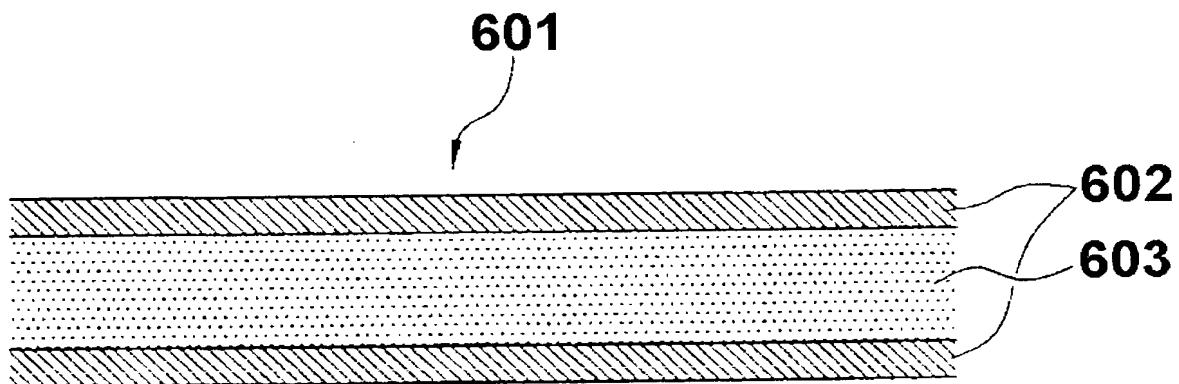
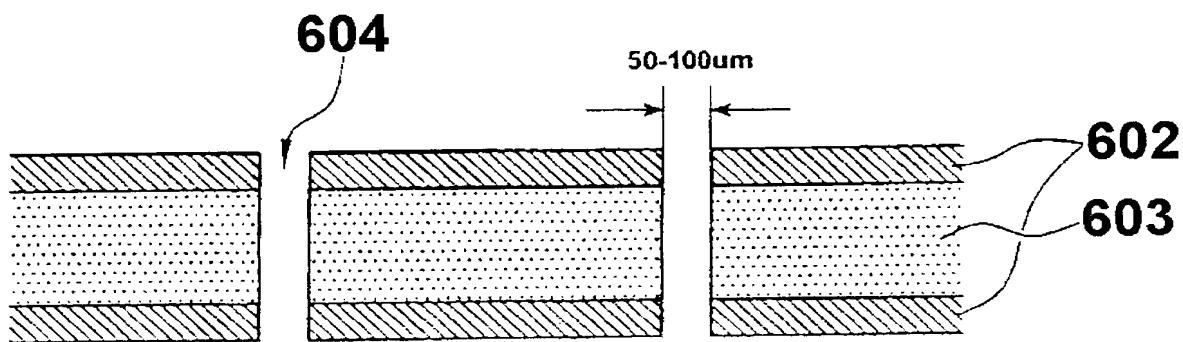


Fig. 6b



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Fig. 6c

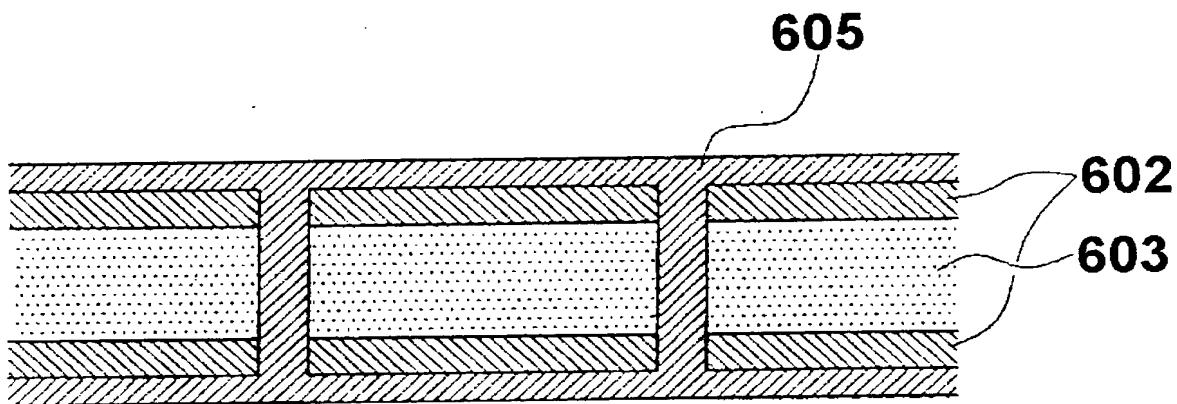
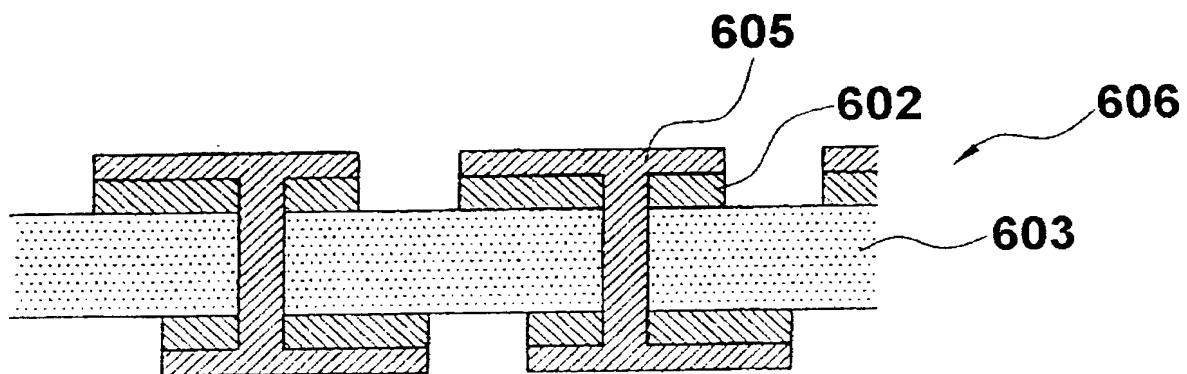


Fig. 6d



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Fig. 6e

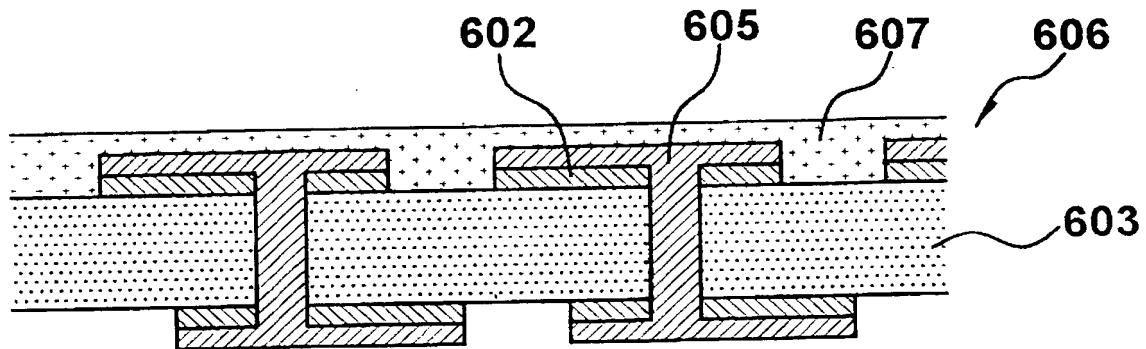
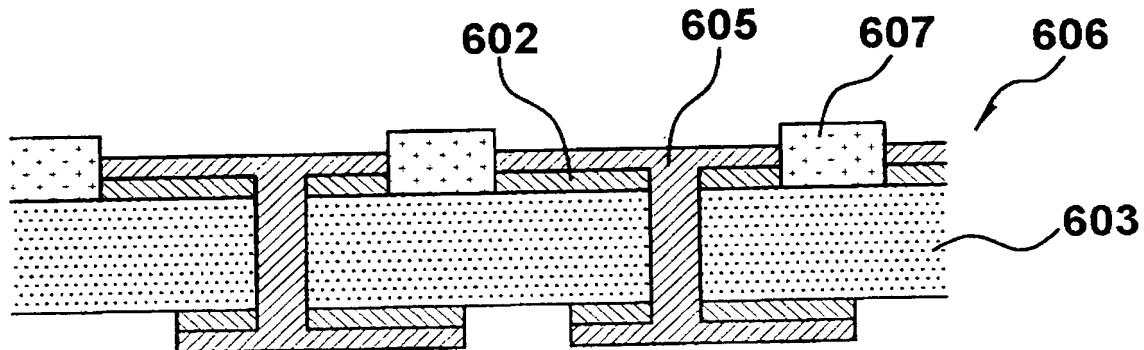


Fig. 6f



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Fig. 7a

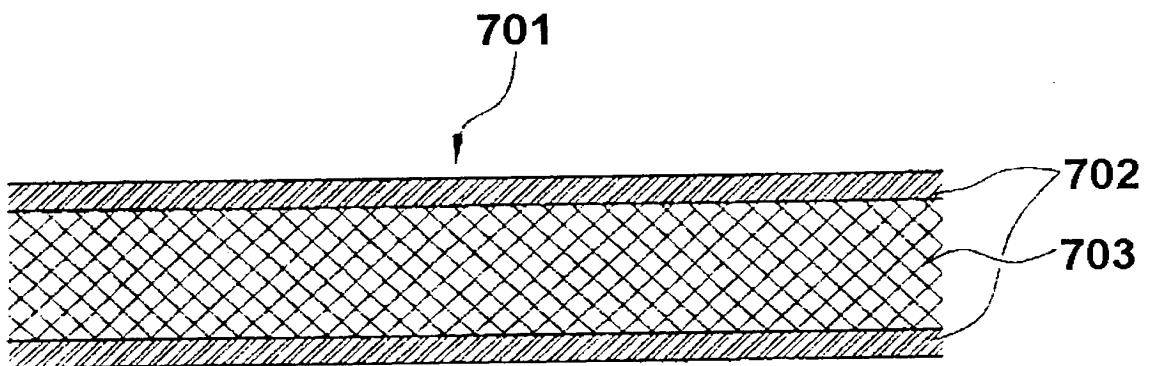
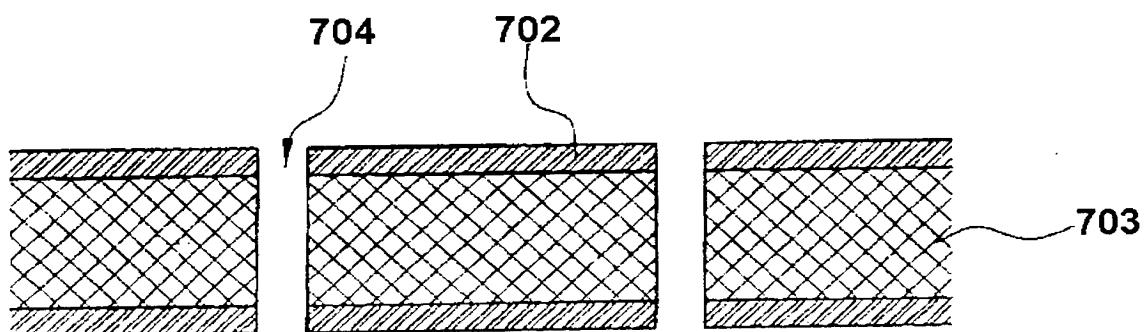


Fig. 7b



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Fig. 7c

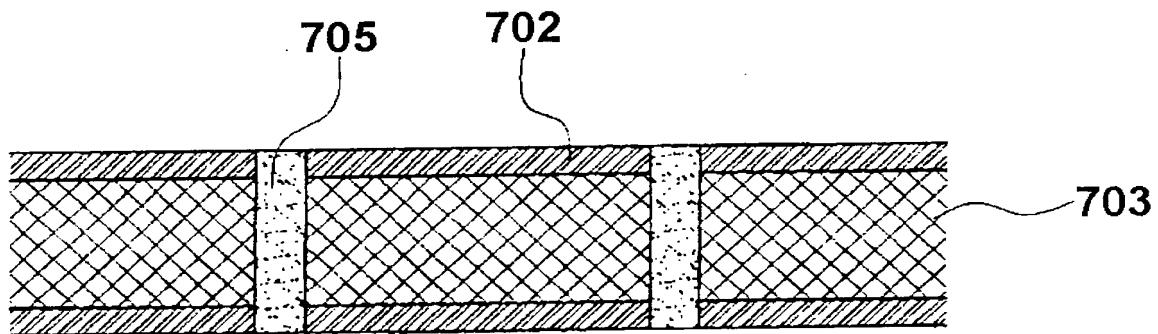
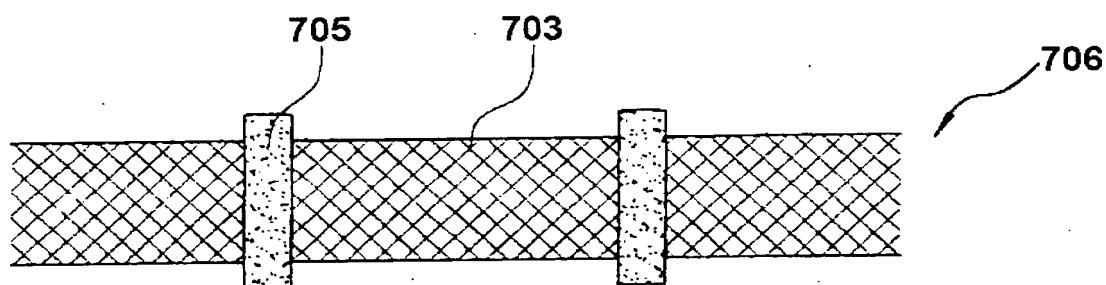
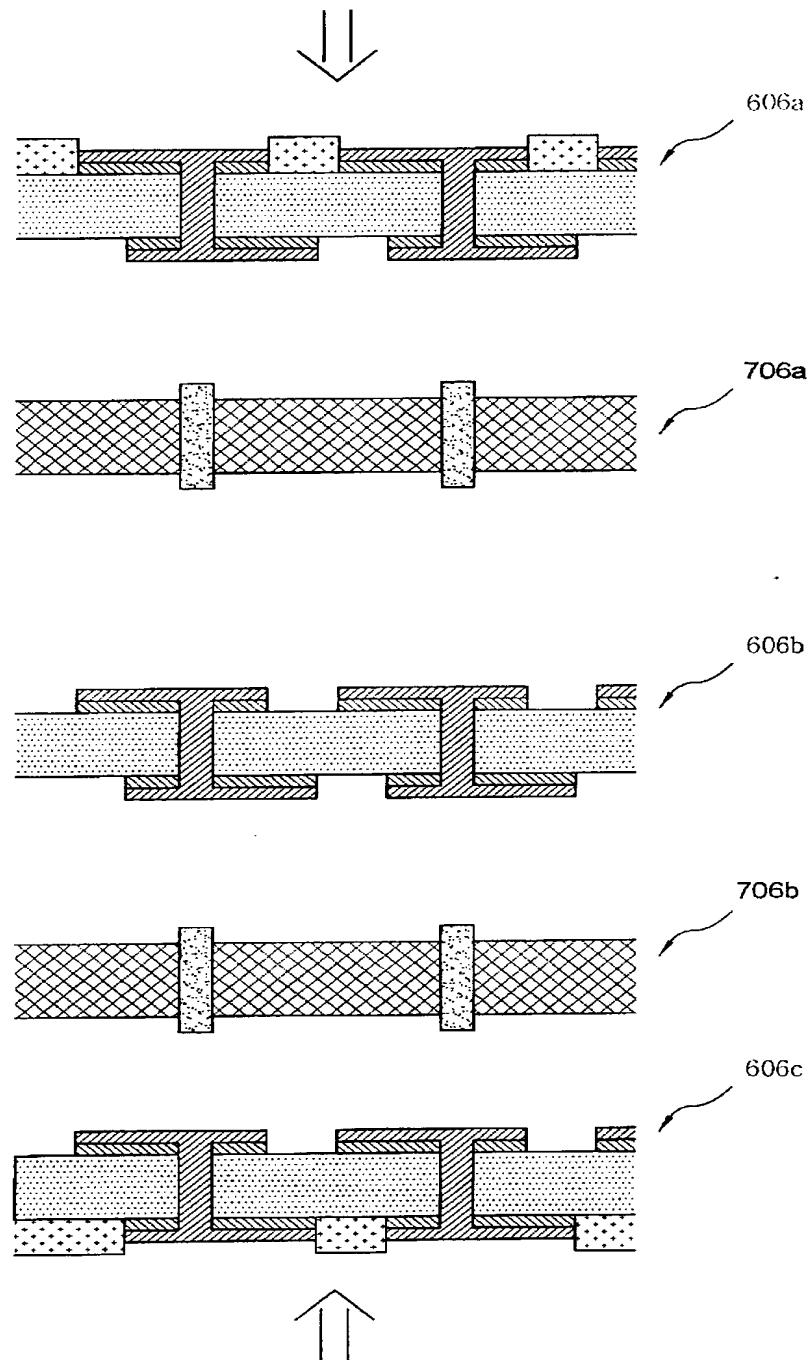


Fig. 7d



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Fig. 8



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Fig. 9

